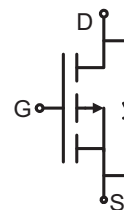


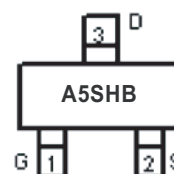
## P-Channel Enhancement Mode Power MOSFET

### Description

The RM2305B uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.



Schematic diagram



Marking and pin assignment



SOT-23 top view

### General Features

- $V_{DS} = -20V, I_D = -4.1A$   
 $R_{DS(ON)} < 95 m\Omega @ V_{GS} = -1.8V$   
 $R_{DS(ON)} < 75 m\Omega @ V_{GS} = -2.5V$   
 $R_{DS(ON)} < 52 m\Omega @ V_{GS} = -4.5V$
- High power and current handling capability
- Lead free product is acquired
- Surface mount package

### Application

- PWM applications
- Load switch
- Power management
- Halogen-free
- P/N suffix V means AEC-Q101 qualified, e.g:RM2305BV

### Package Marking and Ordering Information

| Device Marking | Device  | Device Package | Reel Size | Tape width | Quantity   |
|----------------|---------|----------------|-----------|------------|------------|
| A5SHB          | RM2305B | SOT-23         | Ø180mm    | 8 mm       | 3000 units |

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

| Parameter  | Symbol         | Limit              | Unit       |
|--|----------------|--------------------|------------|
| Drain-Source Voltage                             | $V_{DS}$       | -20                | V          |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 12$           | V          |
| Continuous Drain Current                         | $I_D$          | $T_C = 25^\circ C$ | -4.1       |
|  |                | $T_C = 70^\circ C$ | -3.2       |
|  |                | $T_A = 25^\circ C$ | -3         |
|  |                | $T_A = 70^\circ C$ | -2.3       |
| Drain Current -Pulsed (Note 1)                   | $I_{DM}$       | -15                | A          |
| Maximum Power Dissipation                        | $P_D$          | 1.7                | W          |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150         | $^\circ C$ |

### Thermal Characteristic

|  |                 |    |              |
|--|-----------------|----|--------------|
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 74 | $^\circ C/W$ |
|--|-----------------|----|--------------|

## Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

| Parameter                                 | Symbol              | Condition   | Min   | Typ  | Max  | Unit |
|---|---------------------|---|-------|------|------|------|
| <b>Off Characteristics</b>                |                     |   |       |      |      |      |
| Drain-Source Breakdown Voltage            | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =-250μA  | -20   | -    | -    | V    |
| Zero Gate Voltage Drain Current           | I <sub>DSS</sub>    | V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V  | -     | -    | -1   | μA   |
| Gate-Body Leakage Current                 | I <sub>GSS</sub>    | V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V  | -     | -    | ±100 | nA   |
| <b>On Characteristics (Note 3)</b>        |                     |   |       |      |      |      |
| Gate Threshold Voltage                    | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA   | -0.45 | -0.7 | -1.0 | V    |
| Drain-Source On-State Resistance          | R <sub>DS(on)</sub> | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4.1A   | -     | 39   | 52   | mΩ   |
|   |                     | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-3A   | -     | 58   | 75   |      |
|   |                     | V <sub>GS</sub> =-1.8V, I <sub>D</sub> =-2A   | -     | 88   | 95   |      |
| Forward Transconductance                  | g <sub>FS</sub>     | V <sub>DS</sub> =-5V, I <sub>D</sub> =-2A   | 6     | -    | -    | S    |
| <b>Dynamic Characteristics (Note4)</b>    |                     |   |       |      |      |      |
| Input Capacitance                         | C <sub>iss</sub>    | V <sub>DS</sub> =-4V, V <sub>GS</sub> =0V,<br>F=1.0MHz  | -     | 740  | -    | PF   |
| Output Capacitance                        | C <sub>oss</sub>    |   | -     | 290  | -    | PF   |
| Reverse Transfer Capacitance              | C <sub>rss</sub>    |   | -     | 190  | -    | PF   |
| <b>Switching Characteristics (Note 4)</b> |                     |   |       |      |      |      |
| Turn-on Delay Time                        | t <sub>d(on)</sub>  | V <sub>DD</sub> =-4V, I <sub>D</sub> =-3.3A ,<br>R <sub>L</sub> =-1.2Ω, V <sub>GEN</sub> =-4.5V, R <sub>g</sub> =1Ω | -     | 12   | -    | nS   |
| Turn-on Rise Time                         | t <sub>r</sub>      |   | -     | 35   | -    | nS   |
| Turn-Off Delay Time                       | t <sub>d(off)</sub> |   | -     | 30   | -    | nS   |
| Turn-Off Fall Time                        | t <sub>f</sub>      |   | -     | 10   | -    | nS   |
| Total Gate Charge                         | Q <sub>g</sub>      | V <sub>DS</sub> =-4V, I <sub>D</sub> =-4.1A, V <sub>GS</sub> =-4.5V   | -     | 7.8  | -    | nC   |
| Gate-Source Charge                        | Q <sub>gs</sub>     |   | -     | 1.2  | -    | nC   |
| Gate-Drain Charge                         | Q <sub>gd</sub>     |   | -     | 1.6  | -    | nC   |
| <b>Drain-Source Diode Characteristics</b> |                     |   |       |      |      |      |
| Diode Forward Voltage (Note 3)            | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =-1.6A  | -     | -    | -1.2 | V    |
| Diode Forward Current (Note 2)            | I <sub>S</sub>      |   | -     | -    | 1.6  | A    |

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production



# RATING AND CHARACTERISTICS CURVES (RM2305B)

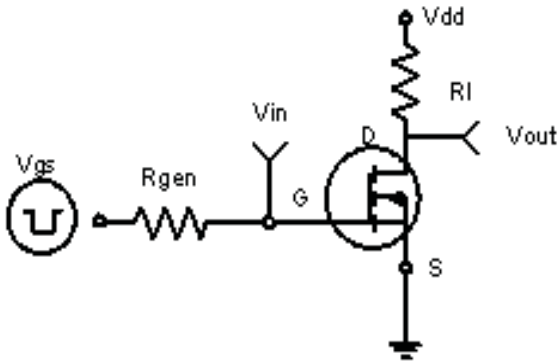


Figure 1: Switching Test Circuit

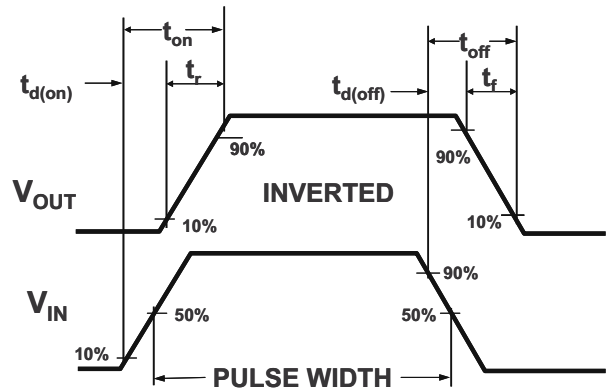
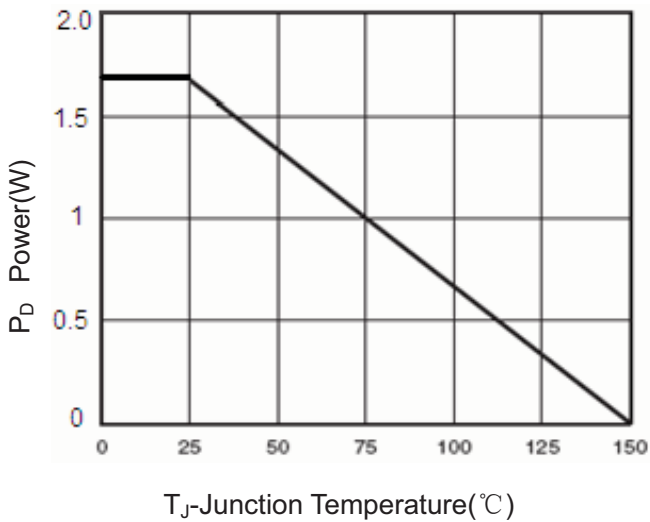
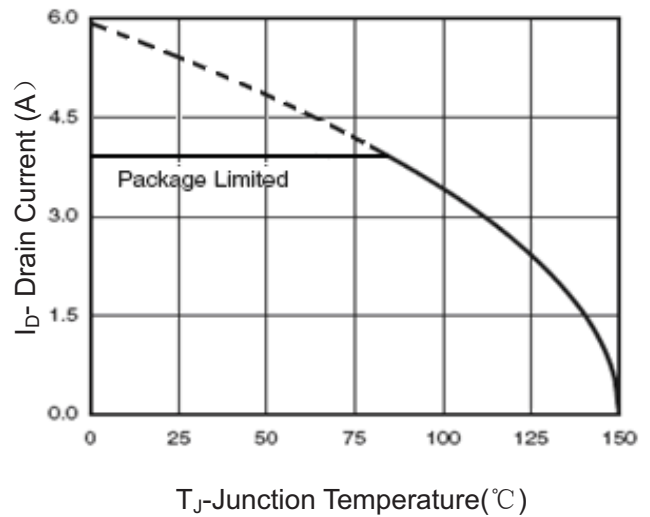


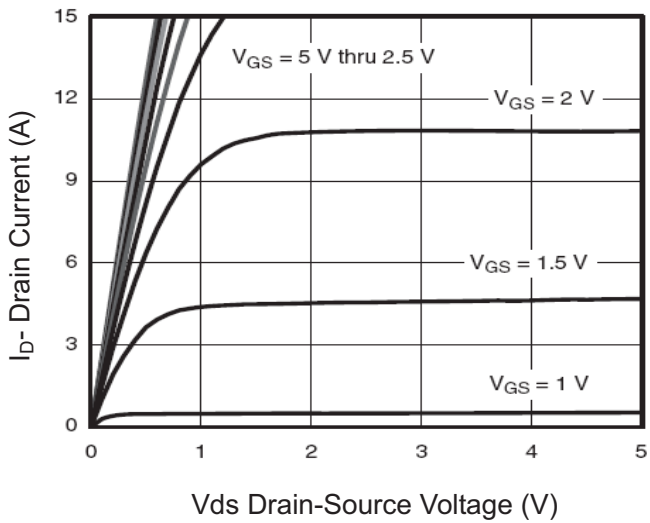
Figure 2: Switching Waveforms



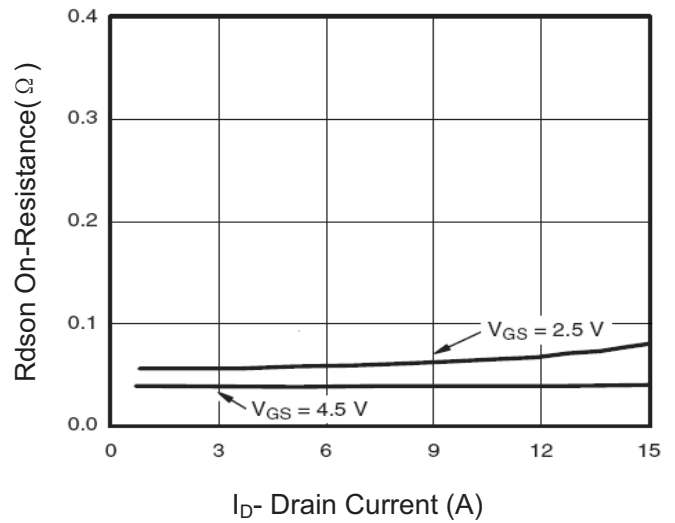
T<sub>J</sub>-Junction Temperature(°C)  
Figure 3 Power Dissipation



T<sub>J</sub>-Junction Temperature(°C)  
Figure 4 Drain Current

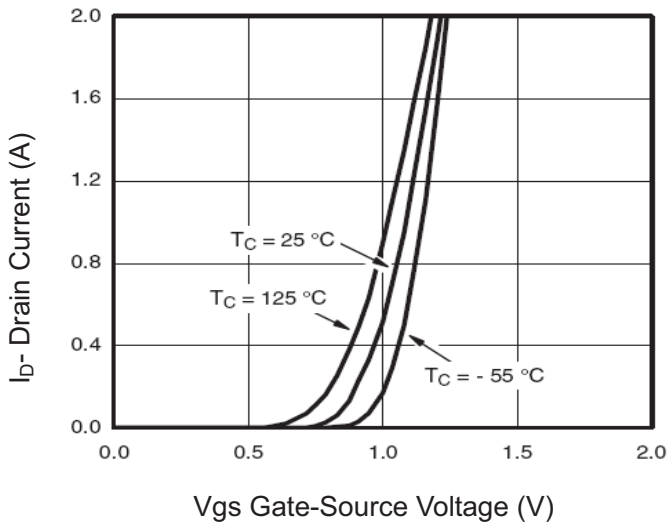


V<sub>ds</sub> Drain-Source Voltage (V)  
Figure 5 Output Characteristics

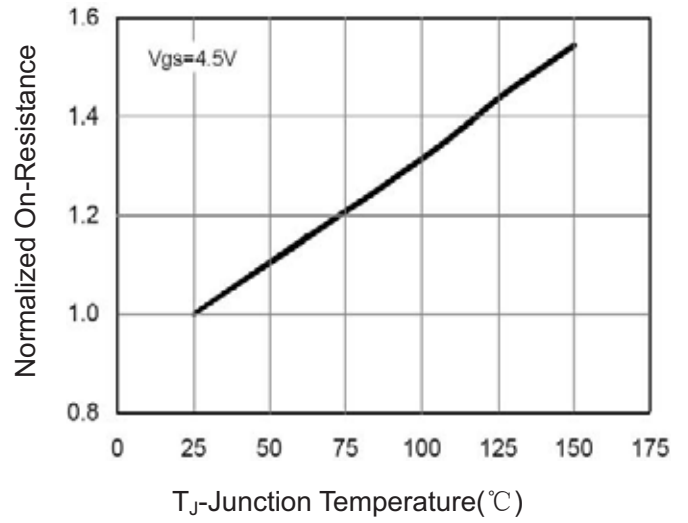


I<sub>D</sub>- Drain Current (A)  
Figure 6 Drain-Source On-Resistance

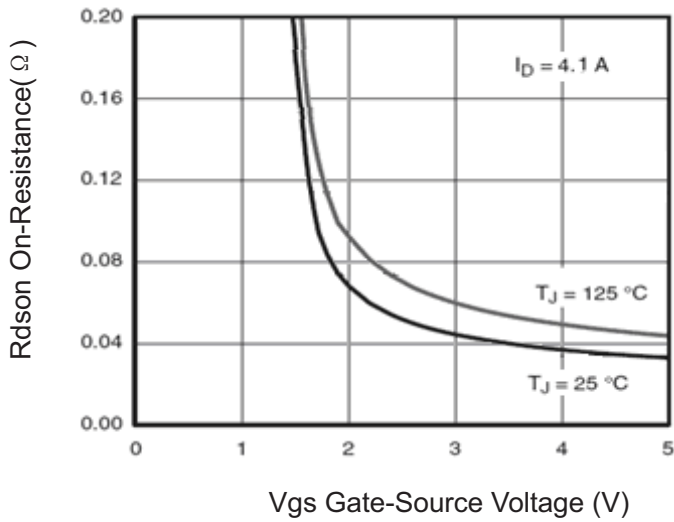
# RATING AND CHARACTERISTICS CURVES (RM2305B)



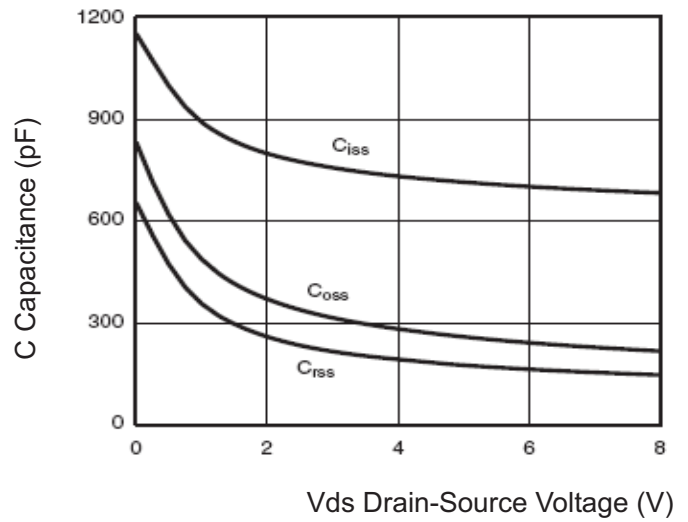
**Figure 7 Transfer Characteristics**



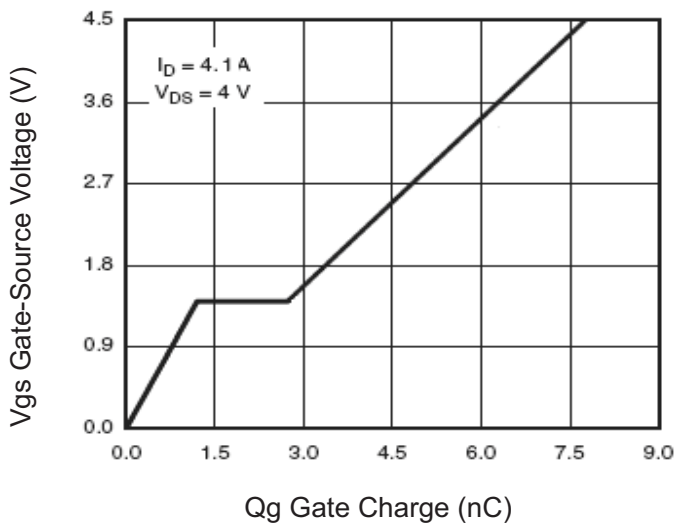
**Figure 8 Drain-Source On-Resistance**



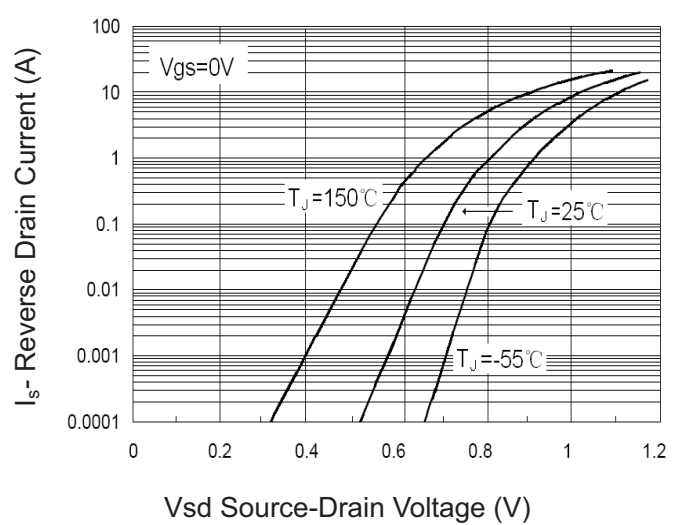
**Figure 9 Rdson vs Vgs**



**Figure 10 Capacitance vs Vds**



**Figure 11 Gate Charge**



**Figure 12 Source- Drain Diode Forward**

## RATING AND CHARACTERISTICS CURVES (RM2305B)

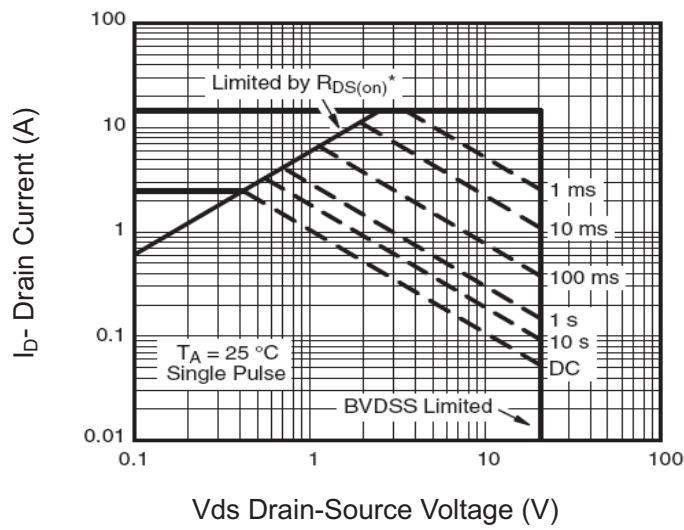


Figure 13 Safe Operation Area

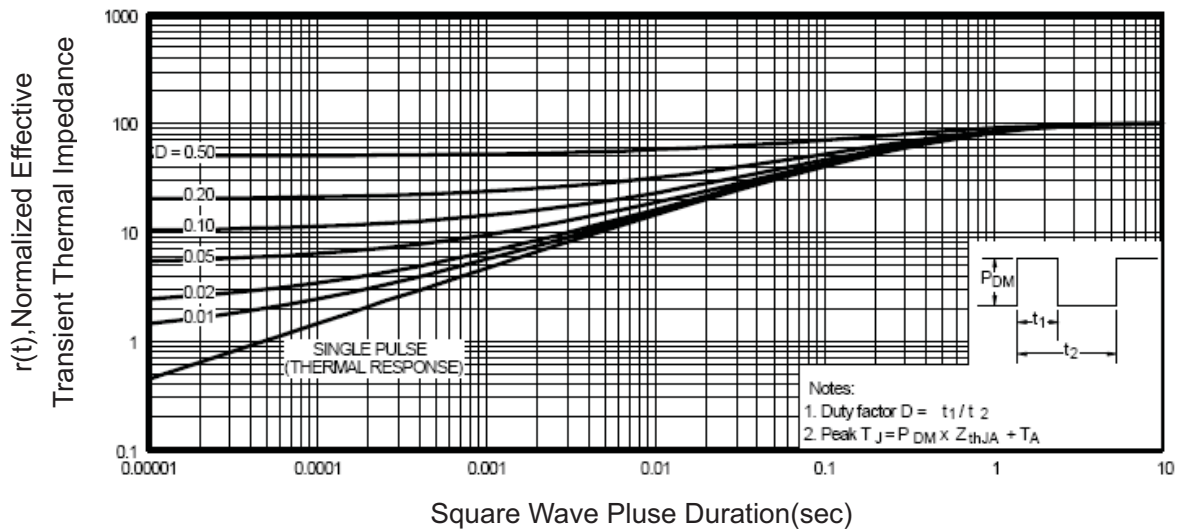
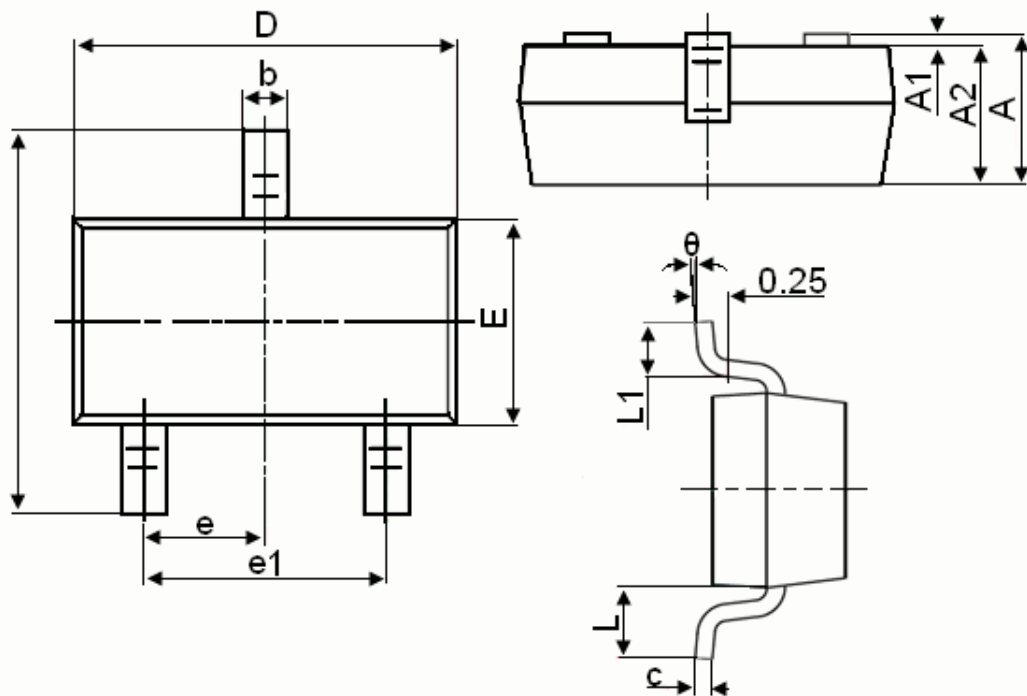


Figure 14 Normalized Maximum Transient Thermal Impedance

## SOT-23 Package Information



| Symbol | Dimensions in Millimeters |       |
|--------|---------------------------|-------|
|        | MIN.                      | MAX.  |
| A      | 0.900                     | 1.150 |
| A1     | 0.000                     | 0.100 |
| A2     | 0.900                     | 1.050 |
| b      | 0.300                     | 0.500 |
| c      | 0.080                     | 0.150 |
| D      | 2.800                     | 3.000 |
| E      | 1.200                     | 1.400 |
| E1     | 2.250                     | 2.550 |
| e      | 0.950TYP                  |       |
| e1     | 1.800                     | 2.000 |
| L      | 0.550REF                  |       |
| L1     | 0.300                     | 0.500 |
| θ      | 0°                        | 8°    |

### Notes

1. All dimensions are in millimeters.
2. Tolerance  $\pm 0.10\text{mm}$  (4 mil) unless otherwise specified
3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
4. Dimension L is measured in gauge plane.
5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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